

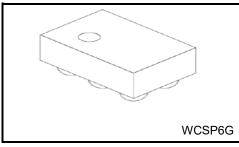
TOSHIBA CMOS Linear Integrated Circuit Silicon Monolithic

TCK42xG Series

Over Voltage Protection MOSFET Gate Driver IC

1. Description

TCK42xG series is Over Voltage Protection Gate Driver IC for External N-channel MOSFET. This product support to MOSFET operating in wide voltage line from 2.7 V to 28 V with various Over Voltage Lock Out lineups. And this features low standby current, less than 1 μA , built in charge pump circuit and MOSFET gate-source protection circuit. Package is very small and thin WCSP6G (1.2 mm x 0.8 mm (typ.), t: 0.35 mm (max)). Thus this is suitable for mobile, wearable system and power management circuit such as load switch application.



Weight: 0.61 mg (typ.)

2. Applications

Load switch circuit for mobile, wearable, and IoT equipment

3. Features

- Gate driver for N-channel Common Drain MOSFET
- Gate driver for N-channel Single High side MOSFET
- High maximum input voltage: V_{IN max} = 40 V
- Wide input voltage operation: V_{IN} = 2.7 to 28 V
- Gate-Source protection circuit
- Over Voltage Lock Out: V_{IN OVLO} = 6.31 V, 10.83 V, 14.29 V, 23.26 V and 27.73 V typ
- Under Voltage Lock Out : V_{IN UVLO} = 2.0 V typ
- Built in Charge pump circuit: Gate source voltage V_{GS} = 5.6 V and 10 V typ
- Low standby current: I_{Q(OFF)} = 0.9 μA max at V_{IN} = 12 V (Except TCK424G, TCK425G)

Start of commercial production 2021-11



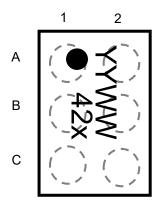
4. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Input voltage	VIN	-0.3 to 40	V
Output voltage	Vout	-0.3 to 40	V
Control voltage	Vст	-0.3 to 6	V
Output GATE voltage	VGATE1,2	-0.3 to 40	V
Power dissipation	PD	800 (Note 1)	mW
Operating temperature range	T _{opr}	-40 to 85	°C
Junction temperature	Tj	150	°C
Storage temperature	T _{stg}	-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note1: Rating at mounting on a board: FR4 board. ($40 \text{ mm} \times 40 \text{ mm} \times 1.6 \text{ mm}$, Cu 4 layer)

5. Top Marking, Pin Assignment (top view)



A1: VGATE1 B1: VGATE2 C1: VOUT A2: VIN B2: GND C2: VCT

YYWW: Lot No.

42x: Device name code

420: TCK420G 421: TCK421G 422: TCK422G 423: TCK423G 424: TCK424G 425: TCK425G



6. Operating Ranges

Characteristics	Symbol	Min.	Тур.	Max.	Unit
Input operation voltage	V _{IN_opr} (Note 2)	2.7	_	28	V
CONTROL High-level input voltage	VIH	1.2	_	5.5	V
CONTROL Low-level input voltage	VIL	_	_	0.4	V

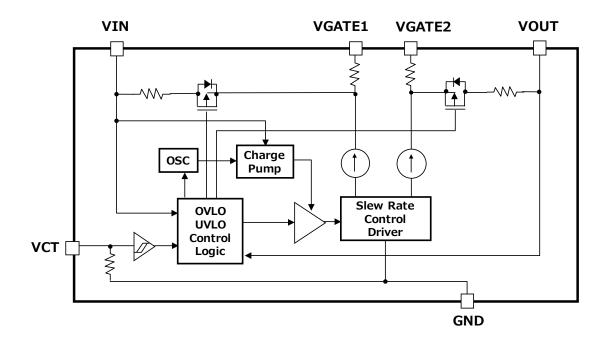
Note 2: $V_{IN_opr} < V_{IN_OVLO\ Max}$ of each product

7. List of Products Number, OVLO and VGS

	OVLO	External MOSFET Gate-
Product number	threshold, falling	Source voltage
	typ (V)	(Control ON) typ (V)
TCK420G	27.73	10
TCK421G	23.26	10
TCK422G	14.29	10
TCK423G	14.29	5.6
TCK424G	10.83	5.6
TCK425G	6.31	5.6



8. Block Diagram



9. PIN Description

PIN	Name	Description
A1	VGATE1	Gate Driver Output for Gate 1 Or OPEN state (Non connection) for Single MOSFET use case
B1	VGATE2	Gate Driver Output for Gate 2
C1	VOUT	Monitoring Output voltage Connecting Output (Source 2) of Common Drain MOSFET Or Connecting Output (Source) of single MOSFET use case
A2	VIN	Input power supply voltage Connecting Output (Source 1) of Common Drain MOSFET Or Connecting Output (Drain) of single MOSFET use case
B2	GND	Ground
C2	VCT	Mode control input terminal VCT=High turn the external MOSFETs ON, VCT=Low, turn the external MOSFETs OFF

10. Operation Table

2.7V ≤ V_{IN} ≤ 28 V (Ta = -40 to 85°C)

VCT	VGATE1, VGATE2
High	Driver ON mode
Open	Driver OFF mode
Low	Dilver OFF Illode



11. Electrical Characteristics

11.1. DC Characteristics (Ta = -40 to 85°C)

Characteristi	cs	Symbol	Test Condition		Ta = 25°C		Ta = -40 (Not	Unit	
Gharaotonou	-	Cymbol	rest containen	Min.	Тур.	Max.	Min.	Max.	Onic
VIN UVLO threshold, Vo	∪⊤ falling	VIN_UVLO	_	_	2.0	_	_	2.5	V
VIN UVLO hysteresis		V _{IN_UVhyst}	_	_	0.2	_	_	_	V
	TCK420G		_	—	27.73	_	26.50	28.50	V
	TCK421G		_		23.26	—	22.34	24.05	V
VIN OVLO threshold, V _{OUT} falling	TCK422G TCK423G	VIN_OVLO	_	_	14.29	_	13.61	14.91	V
	TCK424G		_	_	10.83	—	10.35	11.47	V
	TCK425G		_		6.31	—	5.76	6.87	V
	TCK420G		_	_	0.17	_	_	_	V
VIN OVLO hysteresis	TCK421G TCK422G TCK423G TCK424G TCK425G	VIN_OVhyst	_	_	0.12	_	_	_	V
		IQ(ON)	VCT: High, V _{IN} = 2.7 V	_	140	_	_	200	μА
			V _{CT} : High, V _{IN} = 4 V	_	130	_	_	420	μА
	TCK420G TCK421G		VcT: High, V _{IN} = 5 V	_	140	_	_	300	μА
			V _{CT} : High, V _{IN} = 9 V	_	170	_	_	460	μΑ
	TCK422G		VCT: High, V _{IN} = 12 V	_	185	_	_	490	μА
Input quiescent current (ON state)			V _{CT} : High, V _{IN} = 20 V (Except TCK422G)	_	220		_	560	μА
(ON state)			VCT: High, V _{IN} = 2.7 V	_	75		_	130	μА
			V _{CT} : High, V _{IN} = 4 V	_	95	_	_	150	μΑ
	TCK423G TCK424G		V _{CT} : High, V _{IN} = 5 V	_	100	_	_	160	μА
	TCK425G		V _{CT} : High, V _{IN} = 9 V (Except TCK425G)	_	125	_	_	200	μА
			V _{CT} : High, V _{IN} = 12 V (TCK423G only)	_	140	_	_	225	μА
			V _{CT} : Low, V _{IN} = 2.7 V	_	0.14		_	0.3	μΑ
			VCT: Low, VIN = 4 V	_	0.25	_	_	0.4	μА
			VCT: Low, VIN = 5 V	_	0.28	_	_	0.5	μА
Standby current (OFF state)		IQ(OFF)	V _{CT} : Low, V _{IN} = 9 V (Except TCK425G)	_	0.42	_	_	0.7	μА
			V _{CT} : Low, V _{IN} = 12 V (Except TCK424G, TCK425G)	_	0.52	_	_	0.9	μА
			V _{CT} : Low, V _{IN} = 20 V (TCK420G and TCK421G)	_	0.80	_	_	1.3	μА



11.1. DC Characteristics (Ta = -40 to 85°C) (continued)

Characteris	tice	Symbol	Test Condition	٦	ā = 25°0	C	Ta = -40 (Not	Unit	
Characteristics		Symbol	rest Condition	Min.	Тур.	Max.	Min.	Max.	Offic
			V _{IN} = 2.7 V	_	9.2	_	8	10	٧
			V _{IN} = 5 V	_	10	_	9	11	٧
	TCK420G TCK421G		V _{IN} = 9 V	_	10	_	9	11	V
	TCK421G	V _{GS}	V _{IN} = 12 V	_	10	_	9	11	٧
GATE Drive voltage (VGATE1-VIN)			V _{IN} = 20 V (Except TCK422G)	_	10	_	9	11	٧
(VGATE1-VIN) (VGATE2-VOUT)		(Note 4)	V _{IN} = 24 V (TCK420G only)	_	10	_	9	11	V
			V _{IN} = 2.7 V	_	5.6	_	4.9	6.3	V
TCK423G TCK424G TCK425G			V _{IN} = 5 V	_	5.6	_	5.0	6.3	٧
			V _{IN} = 9 V (Except TCK425G)	_	5.6	_	5.0	6.3	V
		V _{IN} = 12 V (TCK423G only)	_	5.6	_	5.0	6.3	V	
Control pull down resi	istance	RcT	V _{CT} = 5 V	_	550	_		_	kΩ

Note 3: This parameter is warranted by design Note 4: V_{IN} is stable power supply condition



11.2. AC Characteristics (Ta = 25°C, V_{IN} = 5 V, C_{GATE1,2} (Note 5) = 4000 pF)

Characteristics		Symbol	Test Condition (Figure 2,3,4)	Min.	Тур.	Max.	Unit
V _{GS} ON time		ton	Initial startup time VGATE2 - VOUT = 1 V after VCT = High, IOUT = 0 mA	_	2.9	_	ms
V OFF time	TCK420G TCK421G TCK422G	4	Variable Market and Market Market and American Street	_	52	_	μs
V _{GS} OFF time	TCK423G TCK424G TCK425G	toff	VGATE2 - VOUT = 1 V, after V _{CT} = Low, I _{OUT} = 0 mA	_	23	_	μs

11.3. AC Characteristics (Ta = 25°C, V_{IN} = 12 V, C_{GATE1,2} (Note 5) = 4000 pF)

Characte	eristics	Symbol	Test Condition (Figure 2,3,4)	Min.	Тур.	Max.	Unit
V _{GS} ON time		ton	Initial startup time VGATE2 - VOUT = 1 V after VCT = High, IOUT = 0 mA	_	2.9	_	ms
V _{GS} OFF time	TCK420G TCK421G TCK422G	toff	V _{GATE2} - V _{OUT} = 1 V, after V _{CT} = Low, I _{OUT} = 0 mA	_	44	_	μs
	TCK423G				16.4		μS

TCK420G, TCK421G

11.4. AC Characteristics (Ta = 25°C, V_{IN} = 20 V, C_{GATE1,2} (Note 5) = 4000 pF)

Characteristics	Symbol	Test Condition (Figure 2,3,4)	Min.	Тур.	Max.	Unit
VGS ON time	ton	Initial startup time VGATE2 - VOUT = 1 V after VCT = High, IOUT = 0 mA	_	2.9	_	ms
V _{GS} OFF time	toff	V _{GATE2} - V _{OUT} = 1 V, after V _{CT} = Low, I _{OUT} = 0 mA	_	36	_	μS

TCK420G

11.5. AC Characteristics (Ta = 25°C, V_{IN} = 24 V, C_{GATE1,2} (Note 5) = 4000 pF)

Characteristics	Symbol	Test Condition (Figure 2,3,4)	Min.	Тур.	Max.	Unit
V _G S ON time	ton	Initial startup time VGATE2 – VOUT = 1 V after VCT = High, IOUT = 0 mA		2.9		ms
V _{GS} OFF time	toff	V _{GATE2} - V _{OUT} = 1 V, after V _{CT} = Low, I _{OUT} = 0 mA		32	_	μS



11.6. AC Characteristics (Ta = 25°C, C_{GATE1,2} (Note 5) = 4000 pF)

Characte	ristics	Symbol	Test Condition (Figure 5,6)	Min.	Тур.	Max.	Unit
	TCK420G		V_{IN} = 24 to 29 V, $V_{IN \ rising}$ = 2 V/ μ s VGS typ to VGS (VGATE2-VIN) = 1 V I _{OUT} = 0 mA	_	31	_	μs
	TCK421G		V_{IN} = 20 to 25 V, $V_{IN \ rising}$ = 2 V/ μ s V _{GS} typ to V _{GS} (V _{GATE2} -V _{IN}) = 1 V I _{OUT} = 0 mA	_	34	_	μS
OVLO	TCK422G		V_{IN} = 12 to 15 V, $V_{IN \ rising}$ = 2 V/ μ s V _{GS} typ to V _{GS} (V _{GATE2} -V _{IN}) = 1 V I _{OUT} = 0 mA	_	41	_	μs
VGS turn OFF time	TCK423G	tovp	V_{IN} = 12 to 15 V, $V_{IN \ rising}$ = 2 V/ μ s VGS typ to VGS (VGATE2-VIN) = 1 V I _{OUT} = 0 mA	_	16	_	μs
	TCK424G		V _{IN} = 9 to 12 V, V _{IN rising} = 2 V/μs V _{GS} typ to V _{GS} (V _{GATE2} -V _{IN}) = 1 V I _{OUT} = 0 mA	_	18	_	μS
	TCK425G		V_{IN} = 5 to 8 V, $V_{IN \ rising}$ = 2 V/ μ s VGS typ to VGS (VGATE2-VIN) = 1 V I _{OUT} = 0 mA	—	19	_	μS

Note 5: C_{GATE1} and C_{GATE2} are input capacitance connected to each VGATE1 and VGATE2 instead of external MOSFET



11.7. Timing Chart

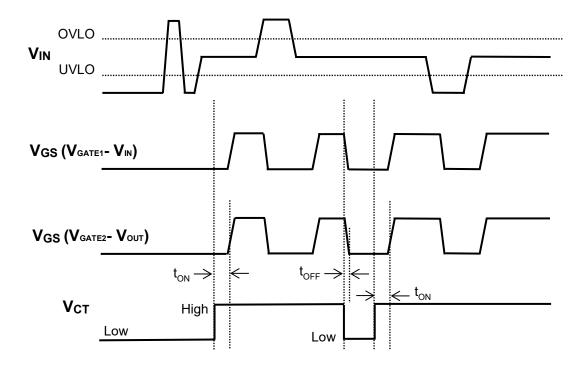


Fig.1 ton, toff

11.8. Switching Waveform and Test circuit

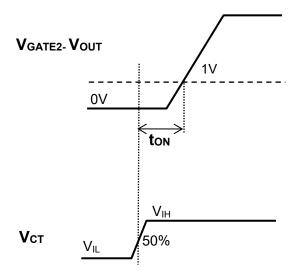


Fig.2 V_{GS} ON time Waveform

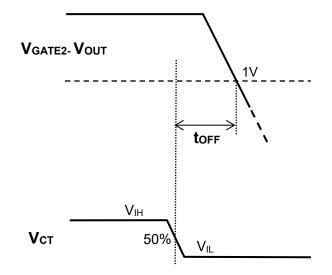


Fig.3 V_{GS} OFF time Waveform



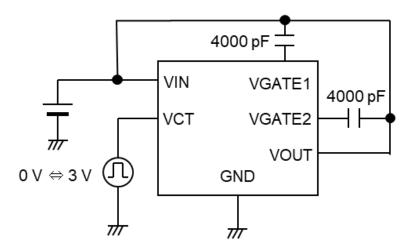


Fig.4 V_{GS} ON and OFF time test circuit

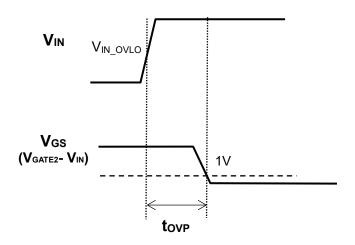


Fig.5 tovp Waveform

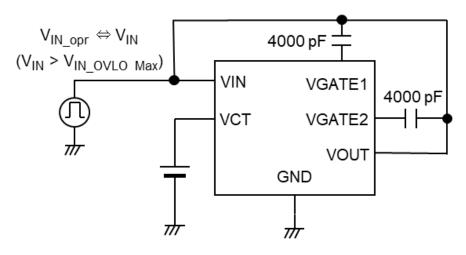
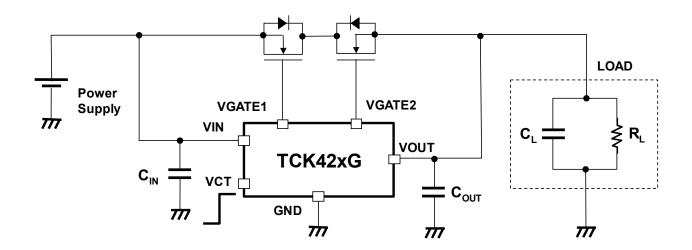


Fig.6 tovp test circuit



12. Application Note

12.1. Common Drain Connection N-channel MOSFET circuit example



Input and Output capacitor

An input capacitor (C_{IN}) and an output capacitor (C_{OUT}) are recommended for the stable operation. And it is effective to reduce voltage overshoot or undershoot due to sharp changes in output current and also for improved stability of the power supply. When used, place C_{IN} and C_{OUT} as close to VIN pin and VOUT pin to improve stability of the power supply.

2. VCT pin

VCT pin is pull down connection to GND. VCT High level voltage must be under 5.5V V_{IH} max.

3. VGATE1.2 pin and VOUT pin

VGATE1 pin is connected to Gate of VIN side MOSFET. VGATE2 pin is connected to Gate of VOUT side MOSFET. VOUT pin is connected to Source of VOUT side MOSFET. When the gate driver IC turns off state, VGATE1 terminal voltage is close to VIN voltage dropped by parasitic diode forward voltage. This circuit works to protect over voltage for VIN side MOSFET Gate-Source terminal. VOUT terminal works to protect VOUT side MOSFET as same circuit.

4. Turn on recovery time after Over Voltage Lock Out (OVLO)

Once VIN is in normal voltage range after OVLO, the turn on recovery time is similar VGS ON time (ton).

5. Under Voltage Lock Out (UVLO) and Over Voltage Lock Out (OVLO)

UVLO and OVLO are designed in these products, but these are not designed to constantly ensure the suppression of the gate driver IC and external MOSFETs within operation limits. Depending on the condition during actual usage, it could affect the electrical characteristic specification and reliability. To select external MOSFETs, please consider enough electrical design margin. When using these products, please read through and understand the concept of dissipation for absolute maximum ratings from the above mention or our 'Semiconductor Reliability Handbook'. Then use these products under absolute maximum ratings in any condition. Furthermore, Toshiba recommends inserting failsafe system into the design.



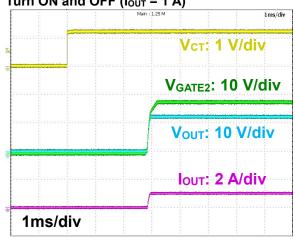
Common Drain Connection N-channel MOSFET Switching Waveform

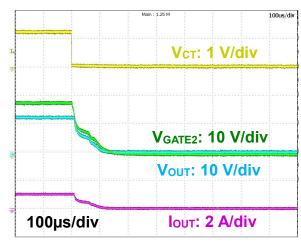
Typical switching waveforms with TOSHIBA MOSFETs

OVP Gate Driver IC	MOSFET		Test conditions	
	Part Number	Description	Turn ON and OFF	Over Voltage Lock Out
TCK423G (V _{GS} = 5.6 V)	TPN1R603PL	Single N-channel MOSFET V_{DSS} : 30 V, V_{GSS} : \pm 20 V $R_{DS(ON)}$: 1.2 m Ω typ at V_{GS} = 10 V Package: TSON Advance	$V_{IN} = 12 \text{ V (TCK423G)}$ $V_{IN} = 20 \text{ V (TCK421G)}$ $I_{OUT} = 1 \text{ A, 3 A}$ $C_{IN} = 1 \mu\text{F}$ $C_{OUT} = 1 \mu\text{F}$ $V_{CT} = 0 \text{ V} \Leftrightarrow 1.2 \text{ V}$ Ta = 25 °C	$V_{IN} = 12 \text{ V} \Leftrightarrow 15 \text{ V} (\text{TCK423G})$ $V_{IN} = 20 \text{ V} \Leftrightarrow 25 \text{ V} (\text{TCK421G})$ $I_{OUT} = 1 \text{ A}$ $C_{IN} = 1 \mu\text{F}$ $C_{OUT} = 1 \mu\text{F}$ $V_{CT} = 1.2 \text{ V}$ $Ta = 25 \text{ °C}$
TCK421G (V _{GS} = 10 V)	TPHR6503PL1	Single N-channel MOSFET V_{DSS} : 30 V, V_{GSS} : \pm 20 V $R_{DS(ON)}$: 0.41 m Ω typ at V_{GS} = 10 V Package: SOP Advance(N)		

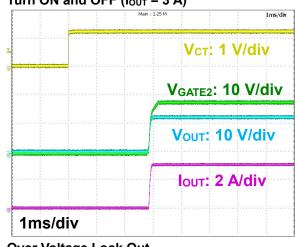
TCK423G + TPN1R603PL x 2pcs

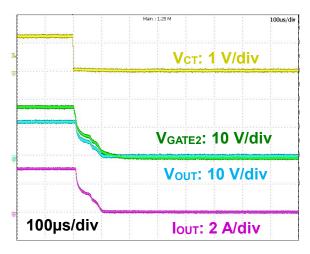




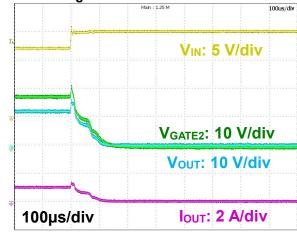


2. Turn ON and OFF (I_{OUT} = 3 A)

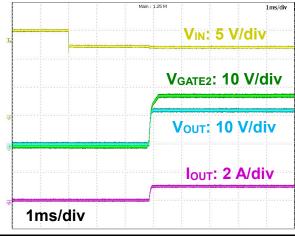








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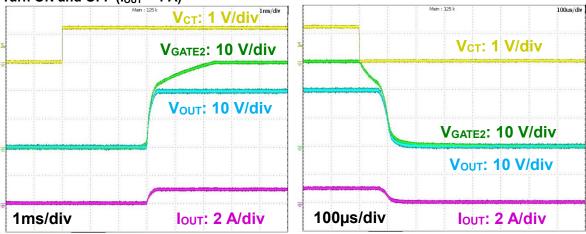


1ms/div

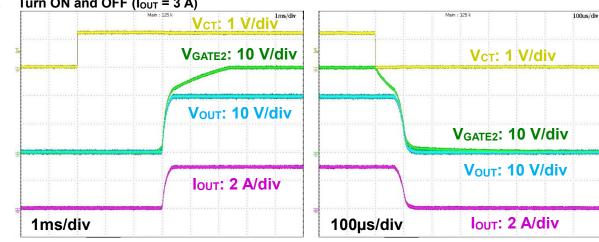


TCK421G + TPHR6503PL1 x 2pcs

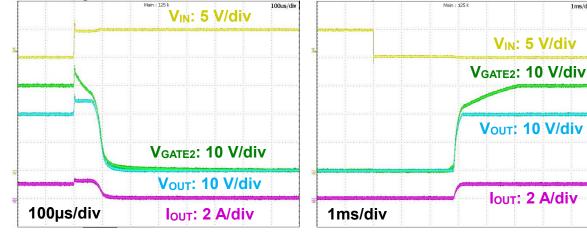
1. Turn ON and OFF (I_{OUT} = 1 A)







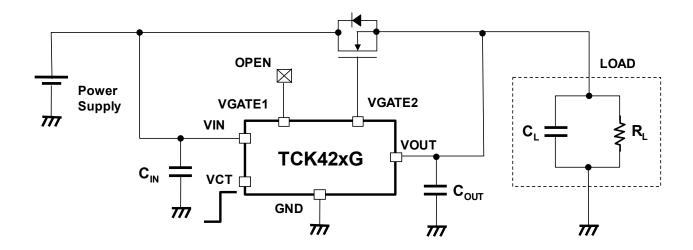




13



12.2. Single N-channel MOSFET circuit example



Input and Output capacitor

An input capacitor (C_{IN}) and an output capacitor (C_{OUT}) are recommended for the stable operation. And it is effective to reduce voltage overshoot or undershoot due to sharp changes in output current and also for improved stability of the power supply. When used, place C_{IN} and C_{OUT} as close to VIN pin and VOUT pin to improve stability of the power supply.

2. VCT pin

VCT pin is pull down connection to GND. VCT High level voltage must be under 5.5V V_{IH} max.

3. VGATE1,2 pin and VOUT pin

VGATE1 pin is OPEN state/Non connection. VGATE2 pin is connected to Gate of MOSFET. VOUT pin is connected to Source of MOSFET. When the gate driver IC turns off state, VGATE2 terminal voltage is close to VOUT voltage dropped by parasitic diode forward voltage. This circuit works to protect over voltage for MOSFET Gate-Source terminal.

4. Turn on recovery time after Over Voltage Lock Out

Once V_{IN} is in normal voltage range after OVLO, the turn on recovery time is similar V_{GS} ON time (ton).

5. Under Voltage Lock Out (UVLO) and Over Voltage Lock Out (OVLO)

UVLO and OVLO are designed in these products, but these are not designed to constantly ensure the suppression of the gate driver IC and external MOSFETs within operation limits. Depending on the condition during actual usage, it could affect the electrical characteristic specification and reliability. To select external MOSFETs, please consider enough electrical design margin. When using these products, please read through and understand the concept of dissipation for absolute maximum ratings from the above mention or our 'Semiconductor Reliability Handbook'. Then use these products under absolute maximum ratings in any condition. Furthermore, Toshiba recommends inserting failsafe system into the design.

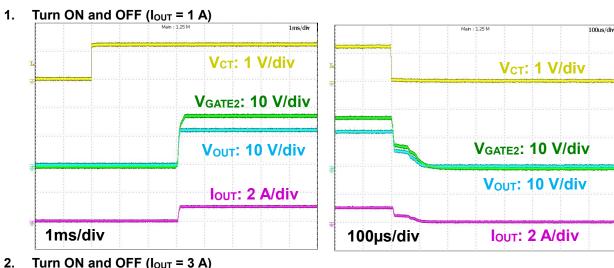


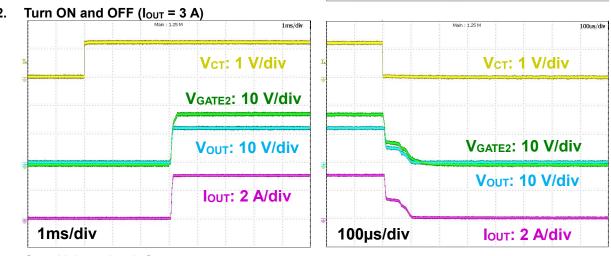
Single N-channel MOSFET Switching Waveform

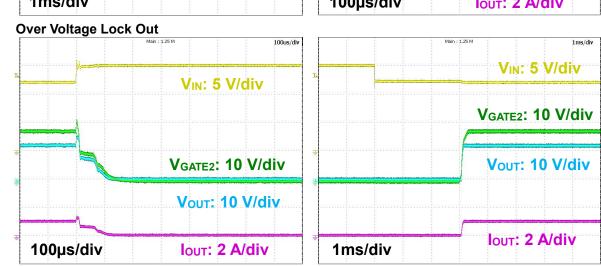
Typical switching waveforms with TOSHIBA MOSFETs

OVP Gate	MOSFET		Test conditions	
Driver IC	Part Number	Description	Turn ON and OFF	Over Voltage Lock Out
TCK423G (V _{GS} = 5.6 V)	TPN1R603PL	Single N-channel MOSFET V_{DSS} : 30 V, V_{GSS} : \pm 20 V $R_{DS(ON)}$: 1.2 m Ω typ at V_{GS} = 10 V Package: TSON Advance	$V_{IN} = 12 \text{ V (TCK423G)}$ $V_{IN} = 20 \text{ V (TCK421G)}$ $I_{OUT} = 1 \text{ A, 3 A}$ $C_{IN} = 1 \mu\text{F}$ $C_{OUT} = 1 \mu\text{F}$ $V_{CT} = 0 \text{ V } \Leftrightarrow 1.2 \text{ V}$ Ta = 25 °C	$V_{IN} = 12 \text{ V} \Leftrightarrow 15 \text{ V} \text{ (TCK423G)}$ $V_{IN} = 20 \text{ V} \Leftrightarrow 25 \text{ V} \text{ (TCK421G)}$ $I_{OUT} = 1 \text{ A}$ $C_{IN} = 1 \mu\text{F}$ $C_{OUT} = 1 \mu\text{F}$ $V_{CT} = 1.2 \text{ V}$ $Ta = 25 \text{ °C}$
TCK421G (V _{GS} = 10 V)	TPHR6503PL1	Single N-channel MOSFET V_{DSS} : 30 V, V_{GSS} : \pm 20 V $R_{DS(ON)}$: 0.41 m Ω typ at V_{GS} = 10 V Package: SOP Advance(N)		

TCK423G + TPN1R603L



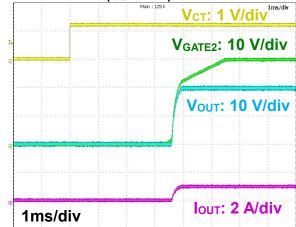


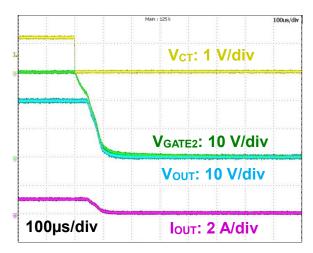




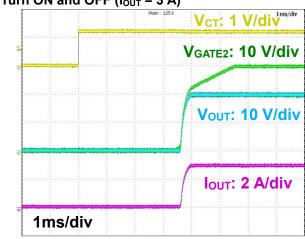
TCK421G + TPHR6503PL1

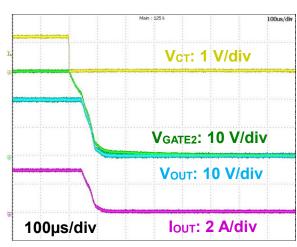




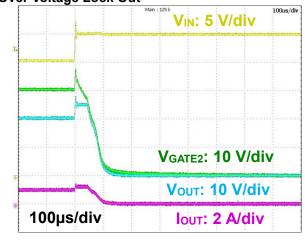


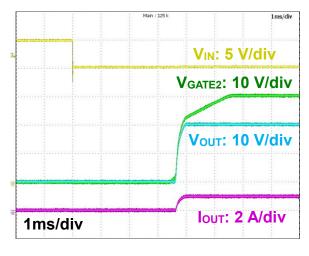
7. Turn ON and OFF ($I_{OUT} = 3 A$)





8. Over Voltage Lock Out

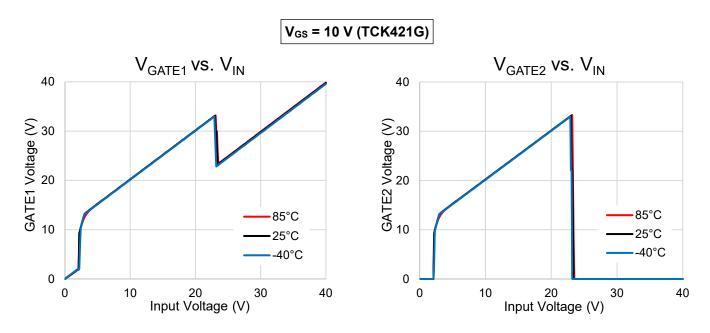


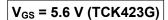


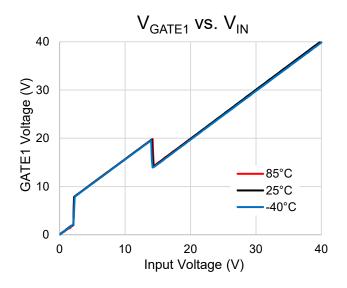


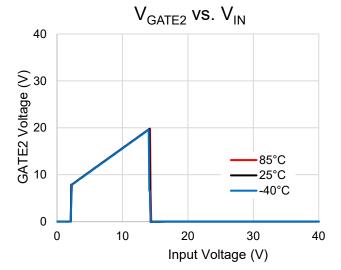
13. Representative Typical Characteristics

13.1. Gate voltage vs. Input voltage





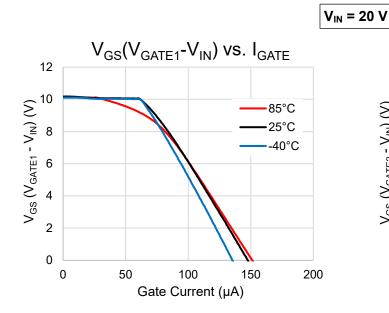


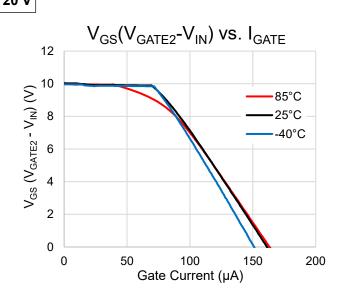


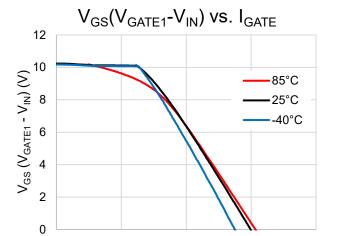


13.2. Gate voltage vs. Gate current

1. $V_{GS} = 10V (TCK421G)$





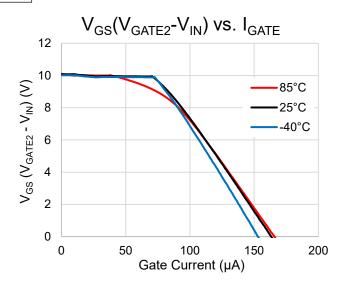


100

Gate Current (µA)

150

200



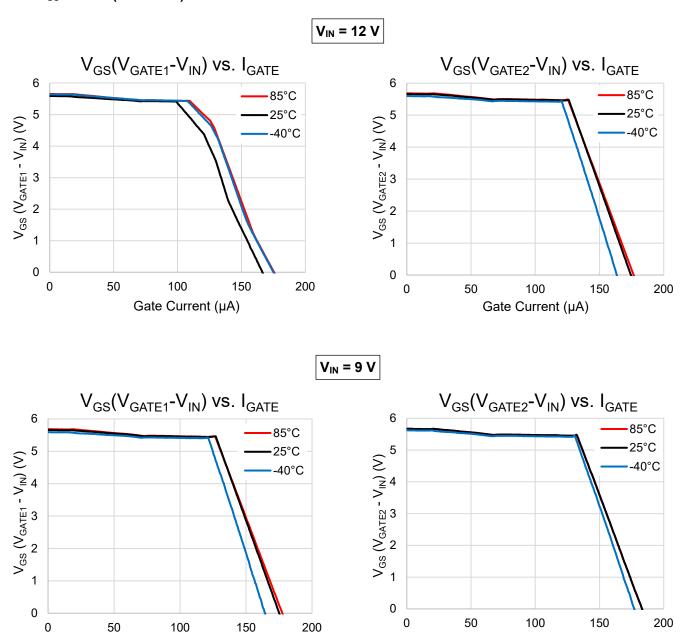
0

50

 $V_{IN} = 12 V$



$V_{GS} = 5.6 \text{ V (TCK423G)}$ 2.



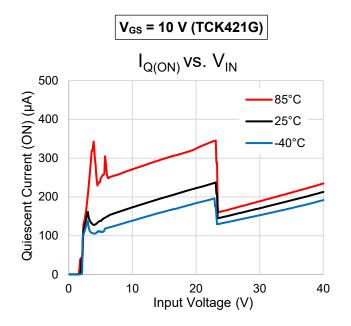
200

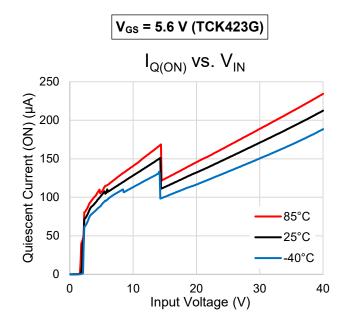
Gate Current (µA)

Gate Current (µA)

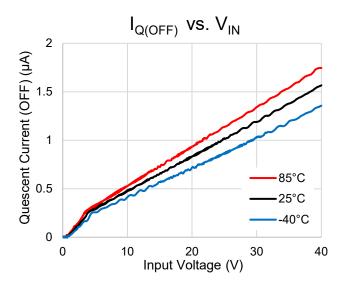


13.3. Quiescent current vs. Input voltage





13.4. Standby current vs. Input voltage (Note 6)

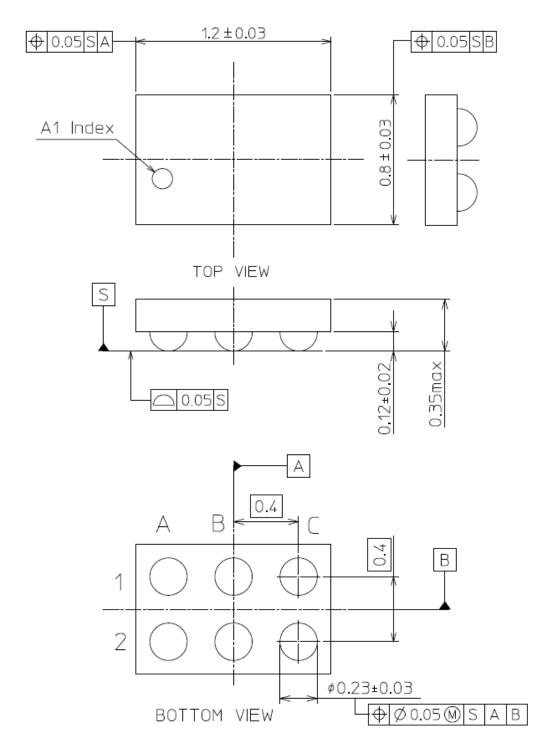


Note 6: Common characteristic of V_{GS} = 10 V and 5.6 V



14. Package Information

WCSP6G Unit: mm

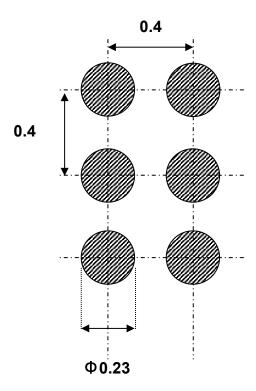


Weight: 0.61 mg (Typ.)



15. Land pattern dimensions for reference only

WCSP6G Unit: mm





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